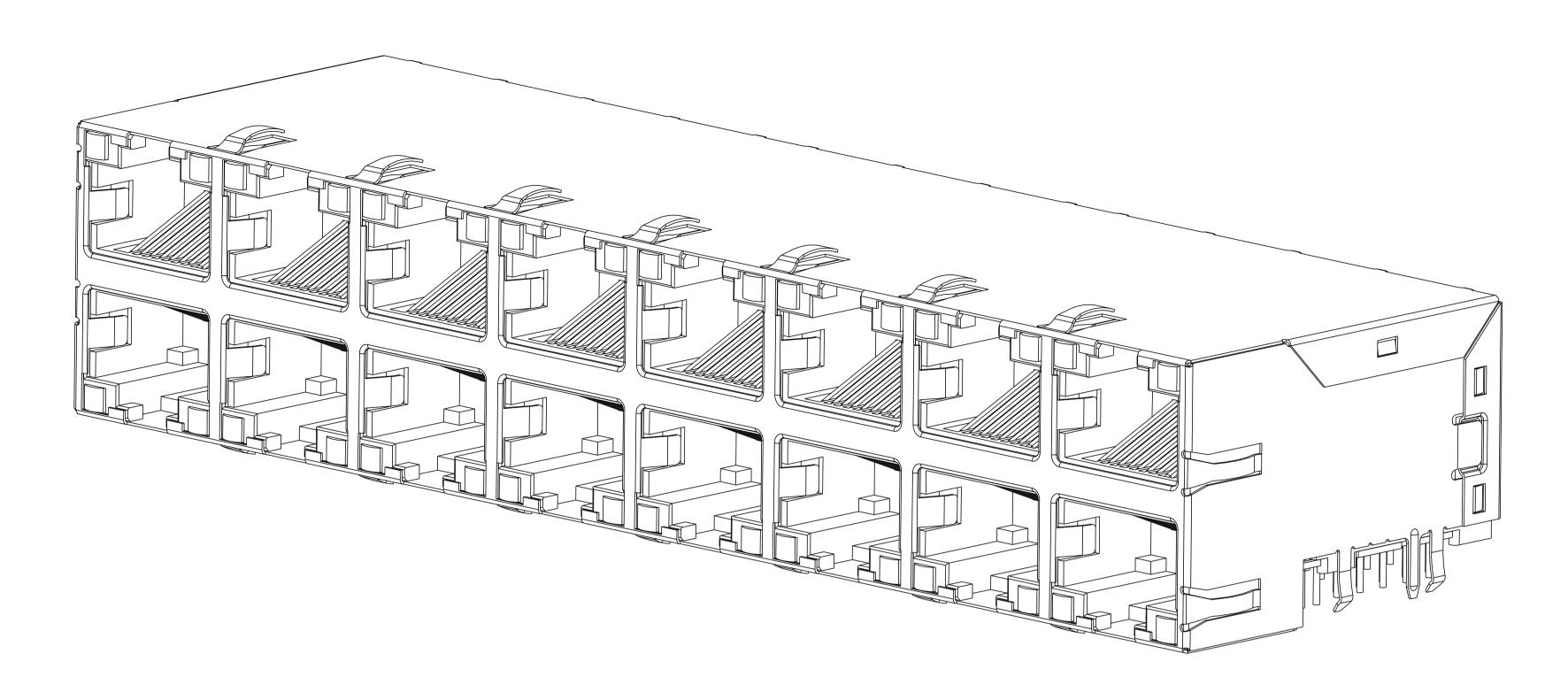
REVISIONS

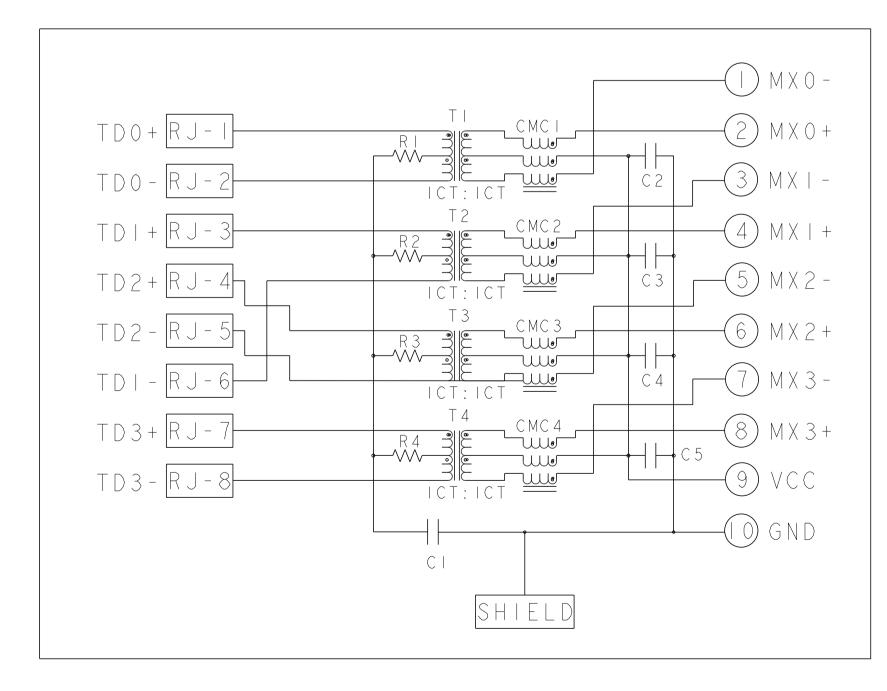
PLITE DESCRIPTION DATE DWN APVD

E EC-1312065 COMPANY LOGO CHANGE 28DEB2014 GC TY



S8G16 GIGABIT CIRCUIT

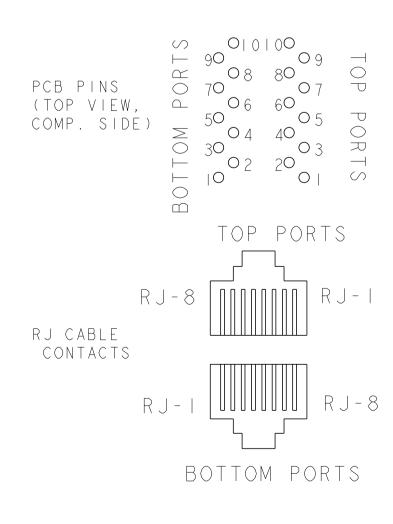
TOP AND BOTTOM PORTS 24



CI = 1000pF, 3kV C2 - C5 = 470pF, 10%, 50V R1-R4 = 75 OHMS, 1/16W

<u>PIN DESIGNATIONS</u>

(REPEAT FOR EACH VERTICAL PAIR OF PORTS)



MATERIALS:

- HOUSING: THERMOPLASTIC, BLACK, FLAMMABILITY RATING UL 94V-0.

- SHIELD: BRASS, PREPLATED WITH 0.76 um MIN SEMI-BRIGHT NICKEL, POST DIPPED WITH 2.54 um MIN SAC SOLDER ON SOLDER TAILS.

- CONTACTS: PHOSPHOR BRONZE, PLATED WITH I.27um MIN OVERALL NICKEL UNDERPLATE, SELECTIVE I.27um MIN GOLD AT MATING INTERFACE AND 2.54um MIN MATTE TIN ON SOLDER TAILS.

- LED: DIFFUSED EPOXY LENS, CARBON STEEL LEAD FRAME LEADS,
PREPLATED WITH 2.03um MIN SILVER OVER 1.02um MIN NICKEL OVER
1.02um MIN COPPER UNDERPLATE, POST PLATED WITH 2.54um MIN MATTE
TIN AND/OR 2.54um MIN SAC SOLDER DIP OR PURE TIN SOLDER DIP.

MAGNETICS:

- APPLICATION: 10/100/1000 BASE-T

- IMPEDANCE: 100 ohm

- TURNS RATIO (CHIP:CABLE): I:I ALL FOUR PAIRS

- OPEN CIRCUIT INDUCTANCE (OCL): 350uH MIN @100kHz, 0.1VRMS, 8mA DC BIAS FROM 0°C TO 70°C, ALL FOUR PAIRS

- RISE TIME(10%-90%): 2.5ns TYPICAL;

- ALL FOUR PAIRS BI-DIRECTIONAL

- PERFORMANCE @25°C:

INSERTION LOSS (IL): I.IdB MAX FROM 0.5MHz TO 100MHz RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 40MHz

12-20LOG(f/80)dB MIN FROM 40.IMHz TO 100MHz CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz 33-20LOG(f/50)dB MIN FROM 40.IMHz TO 100MHz

COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz

- ISOLATION VOLTAGE: 2250VDC (MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC AND WITH ALL PORTS CONNECTED.

PART NUMBER, DATE CODE AND COUNTRY OF ORIGIN ARE LOCATED IN THE APPROXIMATE AREA SHOWN. DATE CODE: YYWWD "YY" IS YEAR, "WW" IS WORK WEEK, "D" IS DAY OF WEEK, WITH SUNDAY=I

TRP CONNECTOR LOGO AND AGENCY APPROVAL LOGO ARE LOCATED IN THE APPROXIMATE AREA SHOWN.

RJ45 CAVITIES CONFORM TO FCC RULES AND REGULATIONS PART 68 SUBPART F.

LED ARE DRIVEN WITH CONSTANT CURRENT AT APPROX. 20mA
DOMINANT WAVELENGTH (λ D)
GREEN, 568nm TYP at IF=20mA
YELLOW,588nm TYP at IF=20mA
FORWARD VOLTAGE (VF):

GREEN, 2.2V TYP at IF=20mA
YELLOW, 2.1V TYP at IF=20mA

1 INDICATED MAGNETIC CONNECTIONS ARE SYMMETRICAL AND SUPPORT AUTO-MDI/MDIX.

8 OPERATING TEMPERATURE: FROM 0°C TO 70°C

9 THE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PEAK TEMPERATURE 260°C MAX. 10 SECONDS MAX. IT IS RECOMMENDED THAT THE CONNECTOR SHIELD AND BODY BE MASKED TO PROTECT IT FROM DIRECT EXPOSURE TO THE SOLDER WAVE TO AVOID DAMAGE TO THE CONNECTOR AND LEDS.

2.54	GREEN/YELLOW	GREEN/YELLOW	GREEN/YELLOW	GREEN/YELLOW	7	1-1840377-4
3.30	GREEN/YELLOW	GREEN/YELLOW	GREEN/YELLOW	GREEN/YELLOW	7	1840377-4
DIM A	BOTTOM LED 2 (LEFT)	BOTTOM LED 1 (RIGHT)	TOP LED 2 (LEFT)	TOP LED 1 (RIGHT)	REAR PCB GND TABS	PART NUMBER
	THIS DRAWING IS A C DIMENSIONS:	TOLERANCES LINIESS	DWN 14NOV2009 RICHARD QIAN CHK 14NOV2009 FRANK LIU APVD 14NOV2009 LIJUN RAO		CONNECTO	DR DONGGUAN CHINA
		0 PLC ±0.25 1 PLC ±0.25 2 PLC ±0.25 3 PLC ±- 4 PLC ±-	MAGJACK	DESC 2 X 8 S 8 G 6		ET W/ LED
	PRODUCT SPEC 08- 04004	ANGLES ±- APPLICATION SPEC -	STACK Non-PoE CUSTOMER DRAWING	A 1 C-1	840377 SCALE 4:1 SHEET	- I OF 4 REV F

